

# **Automotive MOSFET**

# **OptiMOS™-5 Power-Transistor**







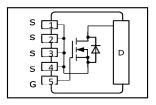
#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL3 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested



General automotive applications.





**Product Summary** 

$V_{\mathrm{DS}}$	80	٧
R <sub>DS(on)</sub>	2.1	mΩ
I <sub>D</sub> (chip limited)	220	Α

Туре	Package	Marking
IAUA220N08S5N021	PG-HSOF-5-4	5N08021

# IAUA220N08S5N021



# **Table of Contents**

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	4
Electrical characteristics diagrams	6
Package outline & footprint	10
Revision history	11
Disclaimer	12

IAUA220N08S5N021



# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	V <sub>GS</sub> =10 V, Chip limitation <sup>1)</sup>	220	A
		V <sub>GS</sub> =10V, DC current	220	
		$T_a$ =85 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,3)</sup>	27	
Pulsed drain current <sup>2)</sup>	/ <sub>D,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 μs	677	7
Avalanche energy, single pulse <sup>2)</sup>	E AS	/ <sub>D</sub> =110 A	275	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	220	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25 °C	211	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

IAUA220N08S5N021



# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	-	0.71	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R <sub>thJA</sub>	-	-	22.8	-	

# **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions		Values		
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	80	-	-	v
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 120 \mu A$	2.2	3	3.8	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =80 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	-	0.1	1	μΑ
		$V_{DS}$ =80 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2)</sup>	-	1	100	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =6 V, I <sub>D</sub> =55 A	-	2.5	3.0	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =100 A	-	1.8	2.1	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	-	1.4	-	Ω

IAUA220N08S5N021



Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	1
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	5553	7219	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =40 V, $f$ =1 MHz	-	963	1252	
Reverse transfer capacitance	C <sub>rss</sub>		-	40	60	
Turn-on delay time	t d(on)		-	14	-	ns
Rise time	t <sub>r</sub>	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V,	-	9	-	
Turn-off delay time	t d(off)	$I_{\rm D}$ =100 A, $R_{\rm G}$ =3.5 Ω	-	26	-	
Fall time	t f		-	19	-	
Gate to drain charge  Gate charge total	Q gs Q gd Q g	$V_{DD}$ =40 V, $I_{D}$ =100 A, $V_{GS}$ =0 to 10 V	-	18 81	28 105	
		<b>-</b>	-			-
Gate plateau voltage	V <sub>plateau</sub>	<del> </del>	_	4.8	_	V
Reverse Diode					·	
Diode continous forward current <sup>2)</sup>	I <sub>S</sub>	T <sub>C</sub> =25 °C	-	-	220	А
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 μs	-	-	677	igsqcup
Diode forward voltage	V <sub>SD</sub>	$V_{GS}$ =0 V, $I_F$ =100 A, $T_j$ =25 °C	-	0.9	1.2	V
Reverse recovery time <sup>2)</sup>	t <sub>rr</sub>	V <sub>R</sub> =40 V, I <sub>F</sub> =50A,	-	54	-	ns
Reverse recovery charge <sup>2)</sup>	Q rr	$di_F/dt = 100 A/\mu s$	-	69	-	nC

<sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

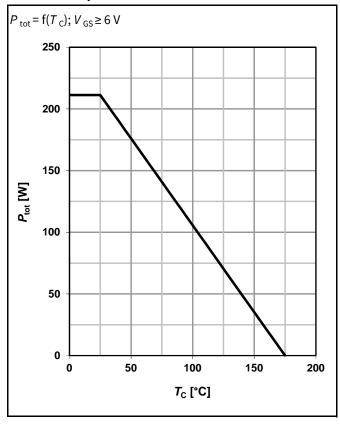
<sup>&</sup>lt;sup>2)</sup> The parameter is not subject to production testing – specified by design.

<sup>&</sup>lt;sup>3)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

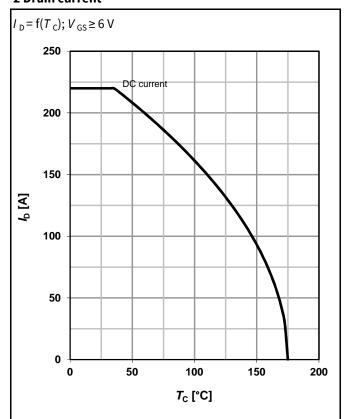


# **Electrical characteristics diagrams**

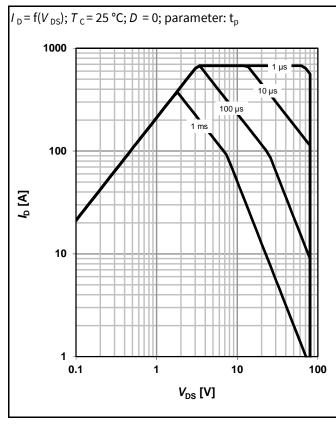
#### 1 Power dissipation



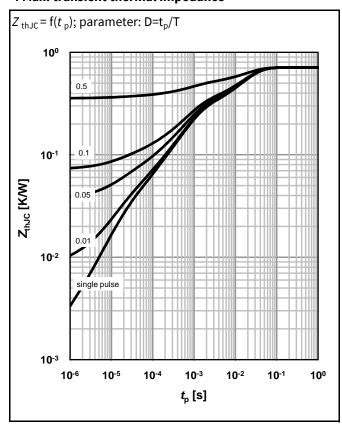
#### 2 Drain current



# 3 Safe operating area

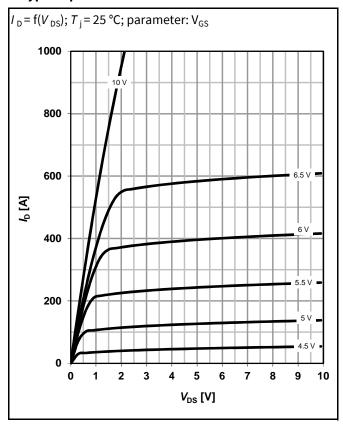


# 4 Max. transient thermal impedance

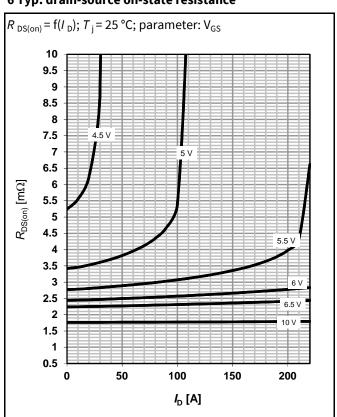




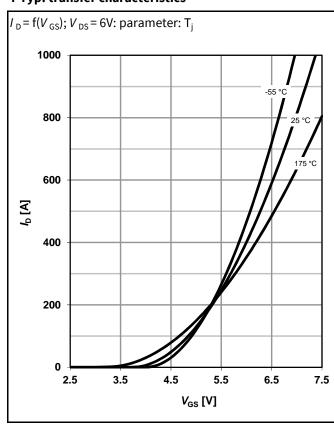
# 5 Typ. output characteristics



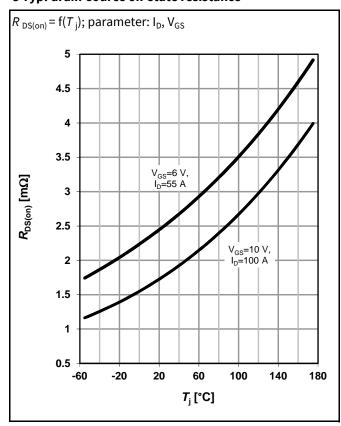
#### 6 Typ. drain-source on-state resistance



# 7 Typ. transfer characteristics

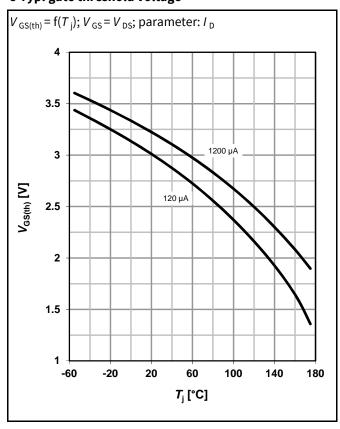


# 8 Typ. drain-source on-state resistance

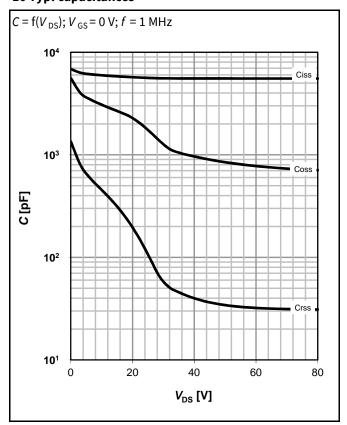


# infineon

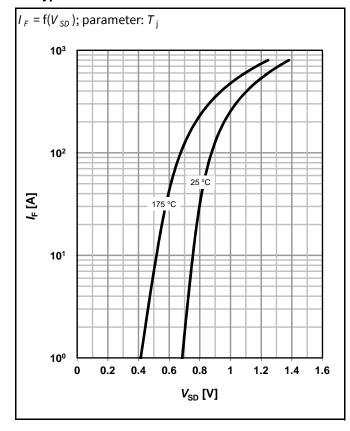
# 9 Typ. gate threshold voltage



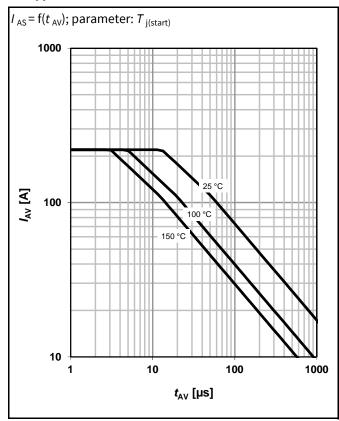
# 10 Typ. capacitances



# 11 Typical forward diode characteristics

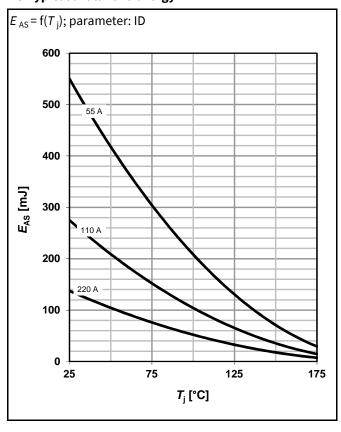


# 12 Typ. avalanche characteristics

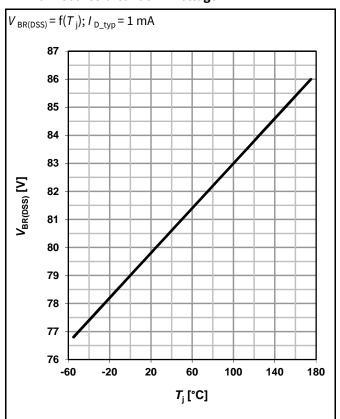


# infineon

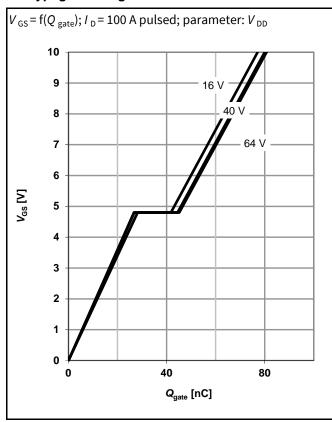
# 13 Typical avalanche energy



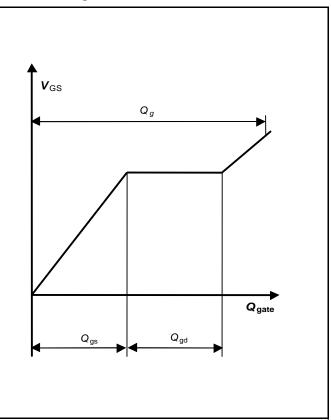
# 14 Drain-source breakdown voltage



# 15 Typ. gate charge



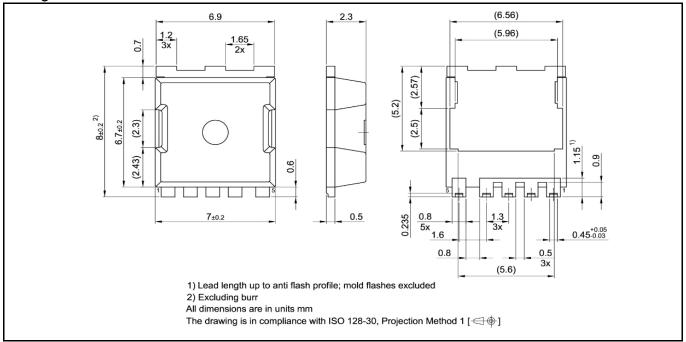
# 16 Gate charge waveforms



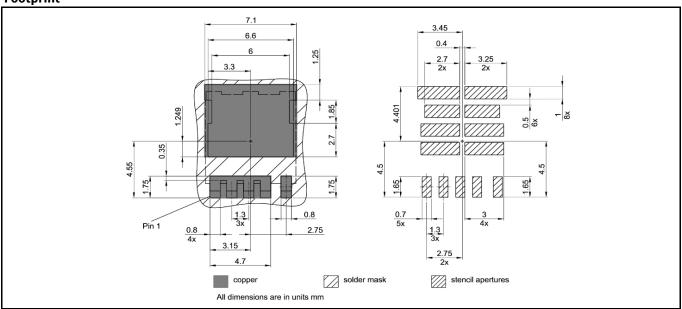
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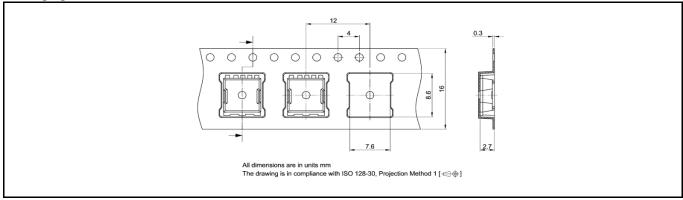
**Package Outline** 



**Footprint** 



**Packaging** 



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# **Revision History**

Revision	Date	Changes		
Revision 1.0	15.03.2021	Final Datasheet		

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